

ABSTRACTHIGH-IMPEDANCE SUBSTRATE

A high-impedance substrate comprising a first layer (1) made of insulating material, having a lower face and an upper face, the substrate comprising  
5 conductor patterns (3) mechanically linked to the substrate, characterised in that, some of the conductor patterns (3) mechanically linked to the substrate are associated with a magnetic tile (5), and in that at least one electrical interconnection (13) puts two  
10 points (9, 11) distinct from one another of a conductor pattern (3) mechanically linked to the substrate in electrical contact, this conductor pattern (3) having an assigned magnetic tile (5), passing above said magnetic tile (5) associated with said conductor  
15 pattern (3) mechanically linked to the substrate.

(Figure 1)